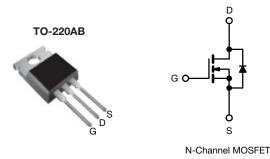
IRF840B



Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.85		
Q _g max. (nC)	30			
Q _{gs} (nC)	4			
Q _{gd} (nC)	7			
Configuration	Single			

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Consumer electronics
- Displays (LCD or plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	ТО-220АВ
Lead (Pb)-free	IRF840BPbF
Lead (Pb)-free and halogen-free	IRF840BPbF-BE3

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	500		
Gate-source Voltage			± 30	V	
Gate-source voltage AC (f > 1 Hz)	V _{GS}	30			
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$		8.7	А	
	V_{GS} at 10 V $T_C = 100 \text{ °C}$	ID	5.5		
Pulsed drain current ^a		I _{DM}	18		
Linear derating factor			1.25	W/°C	
Single pulse avalanche energy ^b	E _{AS}	56	mJ		
Maximum power dissipation	PD	156	W		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	T _J = 125 °C		24)///mm	
Reverse diode dV/dt d		dV/dt	0.37	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.
$$V_{DD}$$
 = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, starting $T_J = 25 \ ^\circ C$

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.8	0/10

SPECIFICATIONS ($T_J = 25 \text{ °C}$, u		,			T)(D		
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		1					
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μA	3	-	5	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zere gete beltege duein ourrent	I	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ 1 $V_{CS} = 400 \text{ V}, V_{CS} = 0 \text{ V}, T_{v} = 125 \text{ °C}$ 10		1			
Zero gate boltage drain current	IDSS	V _{DS} = 400 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 4 A$	-	0.70	0.85	Ω
Forward transconductance a	g _{fs}	V _{DS}	= 20 V, I _D = 4 A	-	3	-	S
Dynamic				•	•		
Input capacitance	C _{iss}		$V_{\rm ext} = 0.V$		527	-	
Output capacitance	C _{oss}	· ·		-	52	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	8	-	
Effective output capacitance, energy related ^b	C _{o(er)}		/// A00.V/ V/ 0.V/	-	46	-	pF
Effective output capacitance, time related ^c	C _{o(tr)}	$V_{\rm DS} = 0$	v to 400 v, $v_{GS} = 0$ v	-	64	-	
Total gate charge	Q _q			-	15	30	
Gate-source charge	Q _{qs}	V _{GS} = 10 V	I _D = 4 A, V _{DS} = 400 V	-	4	-	nC
Gate-drain charge	Q _{qd}			-	7	-	
Turn-on delay time	t _{d(on)}			-	13	26	
Rise time	t _r	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		32			
Turn-off delay time	t _{d(off)}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		34	ns		
Fall time	t _f			-	11	22	
Gate input resistance	R _q	f = 1	MHz, open drain	-	1.8	-	Ω
Drain-Source Body Diode Characteristi	°		· · ·				I
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	
Pulsed diode forward current	I _{SM}			32	A		
Diode forward voltage	V _{SD}	T _J = 25 °	C, I _S = 4 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}		, 40	-	308	-	ns
Reverse recovery charge	Q _{rr}		5 °C, $I_F = I_S = 4 A$,	-	1.8	-	μC
Reverse recovery current	I _{RRM}	dl/dt =	100 A/µs, V _R = 20 V	_	11	_	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

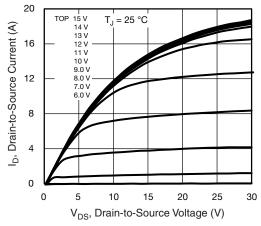


Fig. 1 - Typical Output Characteristics

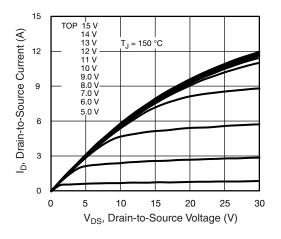
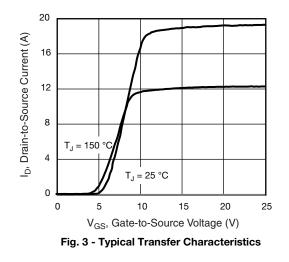


Fig. 2 - Typical Output Characteristics



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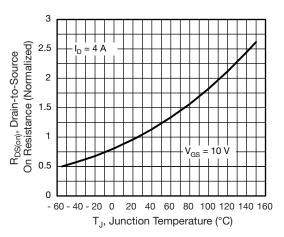


Fig. 4 - Normalized On-Resistance vs. Temperature

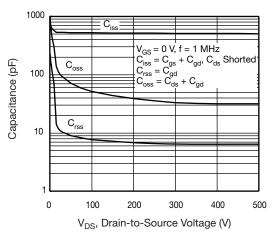
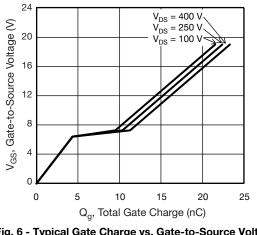


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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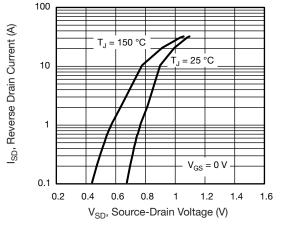
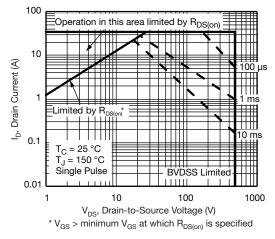
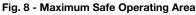


Fig. 7 - Typical Source-Drain Diode Forward Voltage





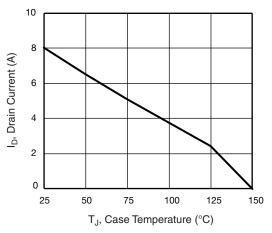


Fig. 9 - Maximum Drain Current vs. Case Temperature

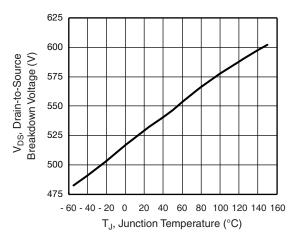
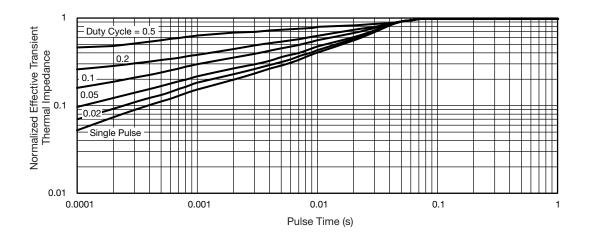
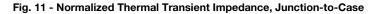


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

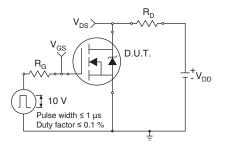




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Fig. 12 - Switching Time Test Circuit

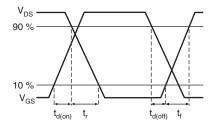


Fig. 13 - Switching Time Waveforms

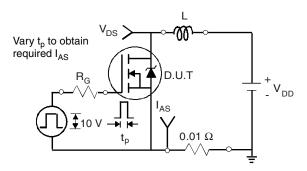


Fig. 14 - Unclamped Inductive Test Circuit

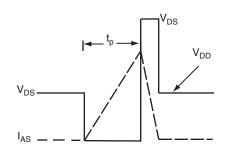


Fig. 15 - Unclamped Inductive Waveforms

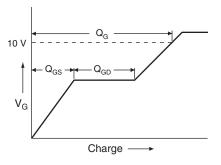


Fig. 16 - Basic Gate Charge Waveform

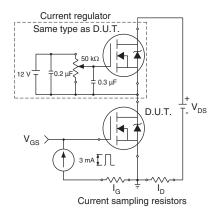
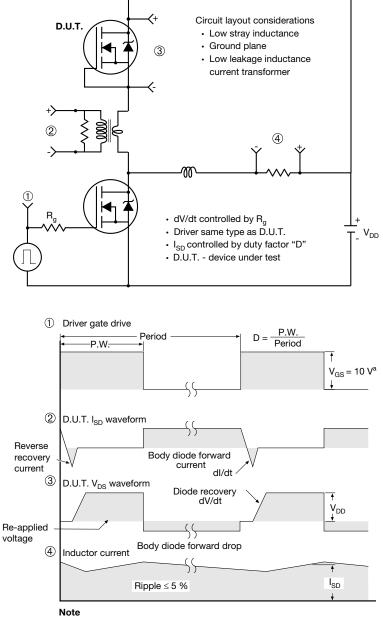


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

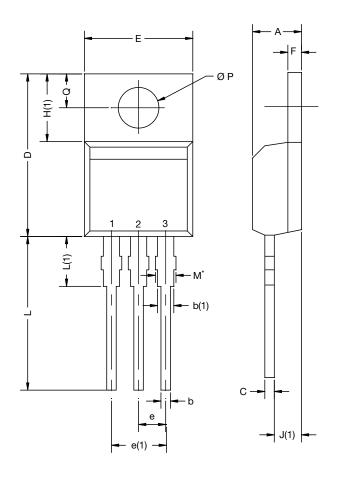
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TO-220-1



DIM	MILLIMETERS		INCHE	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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